

Dual-band CDMA Low Noise Amplifier

Features

- IBM's integrated SiGe BiCMOS technology
- CDMA / AMPS operation in the Cellular and PCS receive bands
- Low noise figure:
 - 1.7B over Cellular band
 - 1.9dB over PCS band
- Low power supply current drain:
 - 10mA High linearity mode
 - 5mA Low linearity mode
 - <0.3mA Bypass mode
 - <1μA Standby mode
- High input IP3: + 8dBm
- 22dB reverse isolation
- Integrated logic and bias control network
- Single-ended RF interface
- Requires Single 2.75-volt power supply

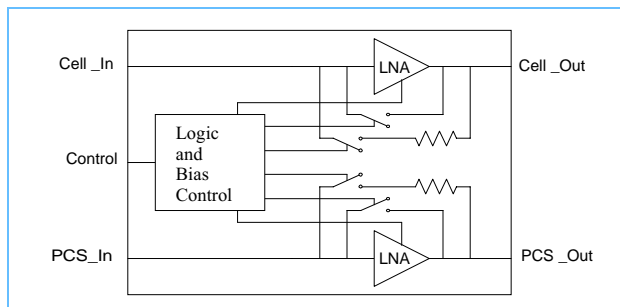
Description

The IBM3604012Q016 Low Noise Amplifier (LNA) is a monolithic device intended for CDMA and AMPS wireless handsets operating in the Cellular and PCS bands. The LNA is fabricated using IBM's Silicon Germanium (SiGe) BiCMOS technology for low noise, high gain and high linearity performance.

The monolithic LNA device consists of the following, as shown in figure 1:

- Two high gain blocks with medium gain and bypass switching options
- Logic and bias control network to support switching options and operating modes

Figure 1. Block Diagram



Note: The LNA is susceptible to damage from electrostatic discharge (ESD). Observe normal ESD precautions at all times when handling or using the device.

Applications

- Single and dual mode CDMA and AMPS handsets receiving in the Cellular 869-894MHz, and PCS 1930-1990MHz bands
- Low noise/high linearity subsystems



QFN 16L Package
3.0mm x 3.0mm x 0.90mm

Each gain block is optimized for a single (cellular or PCS) band of operation. The integrated logic and bias control network facilitate band and gain selection. In addition, the device can operate in a high or low linearity mode. The low linearity mode reduces operating current and enables long battery life.

A bypass mode enables the device to handle strong incoming signals with low current drain. A Standby mode for power saving is also available.

The device is housed in a QFN 16 lead chip scale package and requires off-chip passive components for RF matching.

Ordering information:

To order samples of the product or the Evaluation board, please visit:

www.ibm.com/chips/support/howtobuy.html

| Part Number | Description |
|----------------|------------------------------------|
| IBM3604012Q016 | CDMA Dual Band Low Noise Amplifier |
| IBM3604012EVBA | Evaluation Board Assembly |

Input and Output

Figure 2. Pinout

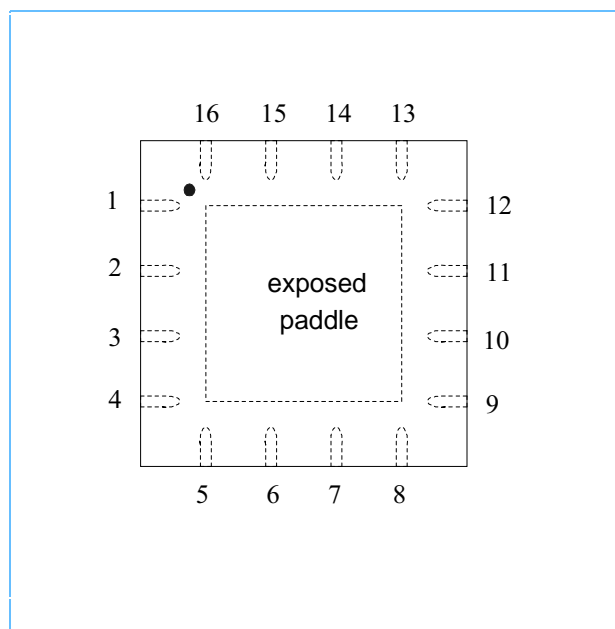
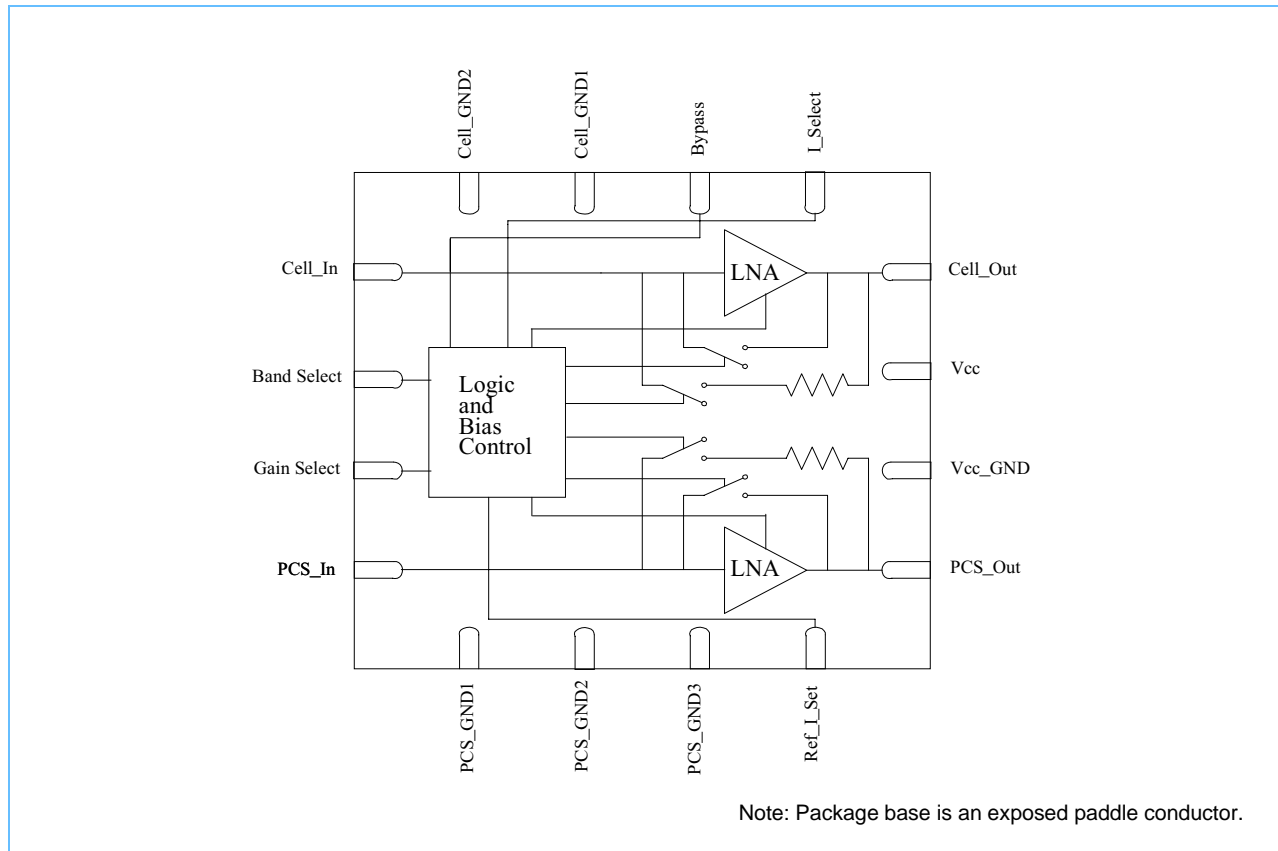


Table 1. Pin Assignments

| Pin | Signal | Type | Description |
|-----|-------------|--------|--------------------------------|
| 1 | Cell_In | Input | Cellular band LNA input |
| 2 | Band Select | Input | Band select logic input |
| 3 | Gain Select | Input | High/Mid gain logic input |
| 4 | PCS_In | Input | PCS band LNA input |
| 5 | PCS_GND1 | Ground | PCS signal ground |
| 6 | PCS_GND2 | Ground | PCS signal ground |
| 7 | PCS_GND3 | Ground | PCS signal ground |
| 8 | Ref_I_Set | DC | Current setting pin |
| 9 | PCS_Out | Output | PCS band LNA output |
| 10 | Vcc_GND | Ground | Bias circuit Ground |
| 11 | Vcc | Power | Bias circuit positive supply |
| 12 | Cell_out | Output | Cellular band LNA output |
| 13 | I_Select | Input | High/low linearity logic input |
| 14 | Bypass | Input | bypass switch logic input |
| 15 | Cell_GND1 | Ground | Cellular signal ground |
| 16 | Cell_GND2 | Ground | Cellular signal ground |
| ep | IC Ground | Ground | RF ground (exposed paddle) |

Figure 3. Functional Block Diagram



Electrical and Thermal Characteristics

Table 2. Absolute Maximum and Minimum Ratings

| Parameter | Symbol | Min | Max | Units | Notes |
|------------------------------|-----------------|-----|------|-------|--------------------------|
| Supply Voltage | V _{CC} | -- | 3.6 | volts | |
| Continuous Power Dissipation | | -- | 30 | mW | |
| RF Input Level | Cell_In, PCS_In | -- | +10 | dBm | V _{CC} applied |
| Operating Temperature | | -40 | +85 | °C | |
| Storage Temperature | | -65 | +150 | °C | |
| Lead Temperature | | -- | 240 | °C | Soldering for 10 seconds |

Table 3. DC Electrical Characteristics (25 °C)

| Parameter | Symbol | Min | Typ | Max | Units | Notes |
|--------------------------------|-----------------|------|------|-----------------|-------|-----------------------------------|
| Supply Voltage | V _{CC} | 2.65 | 2.75 | 2.85 | volts | |
| Supply Current | I _{CC} | | 10 | 12.5 | mA | High Linearity mode |
| | | | 5 | 7 | mA | Low Linearity mode |
| | | | <0.3 | 1 | mA | Bypass mode |
| | | | <1.0 | 10 | μA | Standby mode |
| Logic Input Low Voltage Level | V _{IL} | 0.0 | -- | 0.54 | volts | |
| Logic Input High Voltage Level | V _{IH} | 2.4 | -- | V _{CC} | volts | |
| Logic Input Low Current | I _{IL} | -- | -- | -1.5 | nA | V _{IL} = 0.0 |
| Logic Input High Current | I _{IH} | -- | -- | 1.5 | nA | V _{IH} = V _{CC} |

Table 4. Mode Control Truth Table

| Modes of Operation | | | Control Pin Logic | | | |
|--------------------|--------|-----------|-------------------|-------------|----------|--------|
| Band | Gain | Linearity | Band Select | Gain Select | I_Select | Bypass |
| Cellular | High | High | 0 | 1 | 1 | 0 |
| | Mid | High | 0 | 0 | 1 | 0 |
| | High | Low | 0 | 1 | 0 | 0 |
| | Mid | Low | 0 | 0 | 0 | 0 |
| | Bypass | -- | 0 | 0 | 0 | 1 |
| PCS | High | High | 1 | 1 | 1 | 0 |
| | Mid | High | 1 | 0 | 1 | 0 |
| | High | Low | 1 | 1 | 0 | 0 |
| | Mid | Low | 1 | 0 | 0 | 0 |
| | Bypass | -- | 1 | 0 | 0 | 1 |
| Standby Mode | | | 1 | 1 | 1 | 1 |

Table 5. AC Electrical Characteristics, Cellular Band 869-894MHz, High Linearity mode (Current 10mA)

| Parameter | Min | Typ | Max | Units | Notes |
|--|-------|--------|------|-------|----------------------|
| Power Gain | 14.5 | 15.0 | 15.5 | dB | High gain selected |
| | 10.0 | 10.5 | 11.0 | dB | Medium gain selected |
| | -3.5 | -4 | -4.5 | dB | Bypass mode |
| Gain Flatness (869-894 MHz) | -- | +/-0.3 | -- | dB | High gain selected |
| | -- | +/-0.2 | -- | dB | Medium gain selected |
| | -- | +/-0.3 | -- | dB | Bypass mode |
| Noise Figure | -- | 1.7 | 1.9 | dB | High gain selected |
| | -- | 2.4 | 2.8 | dB | Medium gain selected |
| | -- | 6.0 | 6.5 | dB | Bypass mode |
| Input Third Order Intercept Point (IIP3) | +7.5 | +8.5 | -- | dBm | High gain selected |
| | +14.5 | +15.5 | -- | dBm | Medium gain selected |
| | +20.0 | +20.5 | -- | dBm | Bypass mode |
| Input 1dB Compression | -4.5 | -4 | -- | dBm | High gain selected |
| | -0.5 | +0.5 | -- | dBm | Medium gain selected |
| | +4.5 | +5.0 | -- | dBm | Bypass mode |
| Input Return Loss | 7 | 8 | -- | dB | High gain selected |
| | 12 | 15 | -- | dB | Medium gain selected |
| | 6 | 7 | -- | dB | Bypass mode |
| Output Return Loss | 10 | 12 | -- | dB | High gain selected |
| | 6 | 7 | -- | dB | Medium gain selected |
| | 10 | 12 | -- | dB | Bypass mode |
| Reverse Isolation | 20 | 22 | -- | dB | High gain selected |
| | 16 | 18 | -- | dB | Medium gain selected |
| | 3 | 4 | -- | dB | Bypass mode |

Note: Device characteristics measured with IBM3604012EVBA Evaluation Board Assembly. Optimum external input and output matching to 50 ohm terminations. Input power = -30dBm (-15dBm: Bypass mode); $V_{CC} = 2.75$ volts, ambient temperature = 25 °C, and frequency = 880 MHz. Max, Min and Typ values are based on statistical samples from several non-consecutive wafer lots.

Table 6. AC Electrical Characteristics, Cellular Band 869-894MHz, Low Linearity mode (Current 5mA)

| Parameter | Min | Typ | Max | Units | Notes |
|--|-------|--------|------|-------|----------------------|
| Power Gain | 14.0 | 14.5 | 15.0 | dB | High gain selected |
| | 9.5 | 10.0 | 10.5 | dB | Medium gain selected |
| | -3.5 | -4 | -4.5 | dB | Bypass mode |
| Gain Flatness (869-894 MHz) | -- | +/-0.3 | -- | dB | High gain selected |
| | -- | +/-0.2 | -- | dB | Medium gain selected |
| | -- | +/-0.2 | -- | dB | Bypass mode |
| Noise Figure | -- | 1.6 | 1.8 | dB | High gain selected |
| | -- | 2.4 | 2.6 | dB | Medium gain selected |
| | -- | 6 | 6.5 | dB | Bypass mode |
| Input Third Order Intercept Point (IIP3) | 6.5 | +8.0 | -- | dBm | High gain selected |
| | 9.5 | +10.5 | -- | dBm | Medium gain selected |
| | +20.0 | +20.5 | -- | dBm | Bypass mode |
| Input 1dB Compression | -4.5 | -3.5 | -- | dBm | High gain selected |
| | -1.0 | +1.2 | -- | dBm | Medium gain selected |
| | +4.5 | +5.0 | -- | dBm | Bypass mode |
| Input Return Loss | 6 | 8 | -- | dB | High gain selected |
| | 10 | 14 | -- | dB | Medium gain selected |
| | 6 | 7 | -- | dB | Bypass mode |
| Output Return Loss | 10 | 12 | -- | dB | High gain selected |
| | 6 | 7 | -- | dB | Medium gain selected |
| | 10 | 12 | -- | dB | Bypass mode |
| Reverse Isolation | 20 | 22 | -- | dB | High gain selected |
| | 16 | 18 | -- | dB | Medium gain selected |
| | 3 | 4 | -- | dB | Bypass mode |

Note: Device characteristics measured with IBM3604012EVBA Evaluation Board Assembly. Optimum external input and output matching to 50 ohm terminations. Input power =-30dBm (-15dBm: Bypass mode); V_{CC} = 2.75 volts, ambient temperature = 25 °C, and frequency = 880 MHz. Max, Min and Typ values are based on statistical samples from several non-consecutive wafer lots.

Table 7. AC Electrical Characteristics, PCS Band 1930-1990MHz, High Linearity mode (Current 10mA)

| Parameter | Min | Typ | Max | Units | Notes |
|--|------|--------|------|-------|----------------------|
| Power Gain | 13.0 | 13.5 | 14.0 | dB | High gain selected |
| | 12.0 | 12.5 | 13.0 | dB | Medium gain selected |
| | 6.0 | -6.5 | 7.0 | dB | Bypass mode |
| Gain Flatness (1930-1990 MHz) | -- | +/-0.5 | -- | dB | High gain selected |
| | -- | +/-0.4 | -- | dB | Medium gain selected |
| | -- | +/-0.3 | -- | dB | Bypass mode |
| Noise Figure | -- | 1.9 | 2.1 | dB | High gain selected |
| | -- | 2.2 | 2.4 | dB | Medium gain selected |
| | -- | 6.5 | 7.0 | dB | Bypass mode |
| Input Third Order Intercept Point (IIP3) | +5.5 | +6.5 | -- | dBm | High gain selected |
| | +6.0 | +7.0 | -- | dBm | Medium gain selected |
| | +27 | +28 | -- | dBm | Bypass mode |
| Input 1dB Compression | -4.0 | -3.5 | -- | dBm | High gain selected |
| | -3.5 | -3.0 | -- | dBm | Medium gain selected |
| | 6.0 | +6.5 | -- | dBm | Bypass mode |
| Input Return Loss | 10 | 12 | -- | dB | High gain selected |
| | 10 | 13 | -- | dB | Medium gain selected |
| | 8 | 10 | -- | dB | Bypass mode |
| Output Return Loss | 10 | 12 | -- | dB | High gain selected |
| | 10 | 14 | -- | dB | Medium gain selected |
| | 8 | 10 | -- | dB | Bypass mode |
| Reverse Isolation | 20 | 22 | -- | dB | High gain selected |
| | 20 | 22 | -- | dB | Medium gain selected |
| | 6 | 6.5 | -- | dB | Bypass mode |

Note: Device characteristics measured with IBM3604012EVBA Evaluation Board Assembly. Optimum external input and output matching to 50 ohm terminations. Input power =-30dBm (-10dBm: Bypass mode); V_{CC} = 2.75 volts, ambient temperature = 25 °C, and frequency = 1960 MHz. Max, Min and Typ values are based on statistical samples from several non-consecutive wafer lots.

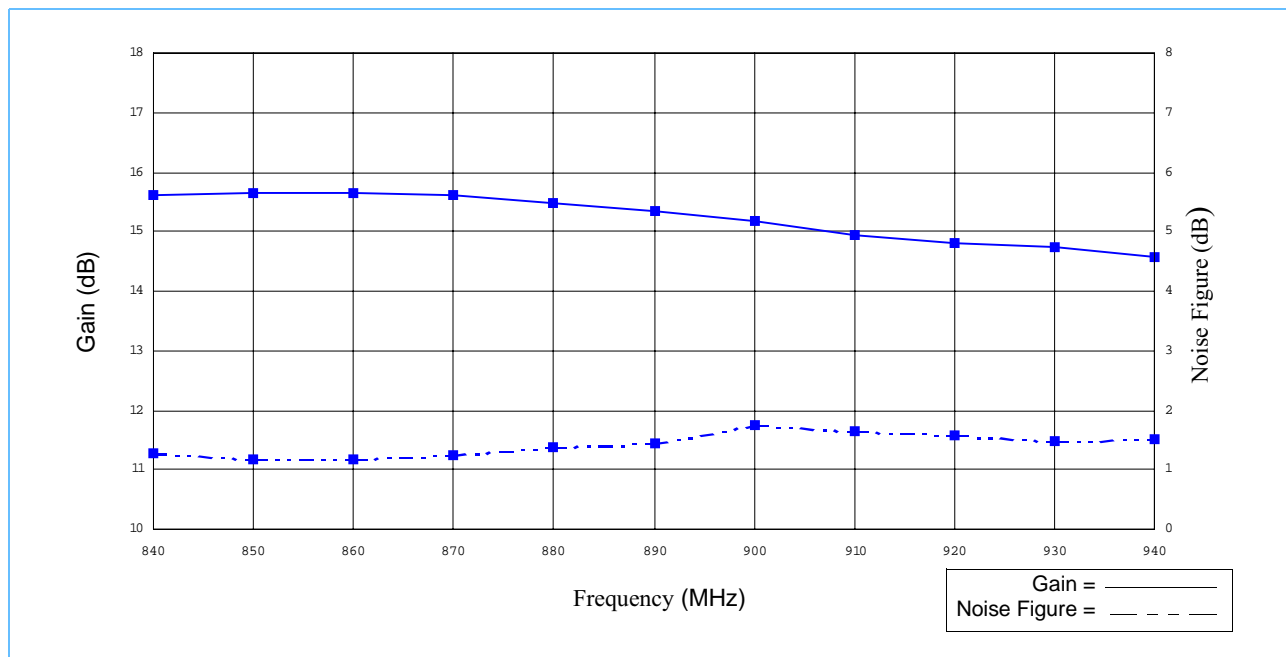
Table 8. AC Electrical Characteristics, PCS Band 1930-1990MHz, Low Linearity mode (Current 5mA)

| Parameter | Min | Typ | Max | Units | Notes |
|--|------|--------|------|-------|----------------------|
| Power Gain | 12.5 | 13.0 | 13.5 | dB | High gain selected |
| | 11.5 | 12.0 | 12.5 | dB | Medium gain selected |
| | 6.0 | -6.5 | 7.0 | dB | Bypass mode |
| Gain Flatness (1930-1990MHz) | -- | +/-0.6 | -- | dB | High gain selected |
| | -- | +/-0.4 | -- | dB | Medium gain selected |
| | -- | +/-0.2 | -- | dB | Bypass mode |
| Noise Figure | -- | 1.9 | 2.2 | dB | High gain selected |
| | -- | 2.3 | 2.5 | dB | Medium gain selected |
| | -- | 6.5 | 7.0 | dB | Bypass mode |
| Input Third Order Intercept Point (IIP3) | -2.5 | -1.5 | -- | dBm | High gain selected |
| | -2.0 | -1.0 | -- | dBm | Medium gain selected |
| | +27 | +28 | -- | dBm | Bypass mode |
| Input 1dB Compression | -4.5 | -3.5 | -- | dBm | High gain selected |
| | -3.0 | -2.0 | -- | dBm | Medium gain selected |
| | 6.0 | +6.5 | -- | dBm | Bypass mode |
| Input Return Loss | 7 | 9 | -- | dB | High gain selected |
| | 10 | 12 | -- | dB | Medium gain selected |
| | 8 | 10 | -- | dB | Bypass mode |
| Output Return Loss | 10 | 12 | -- | dB | High gain selected |
| | 10 | 12 | -- | dB | Medium gain selected |
| | 8 | 10 | -- | dB | Bypass mode |
| Reverse Isolation | 18 | 20 | -- | dB | High gain selected |
| | 20 | 23 | -- | dB | Medium gain selected |
| | 6 | 6.5 | -- | dB | Bypass mode |

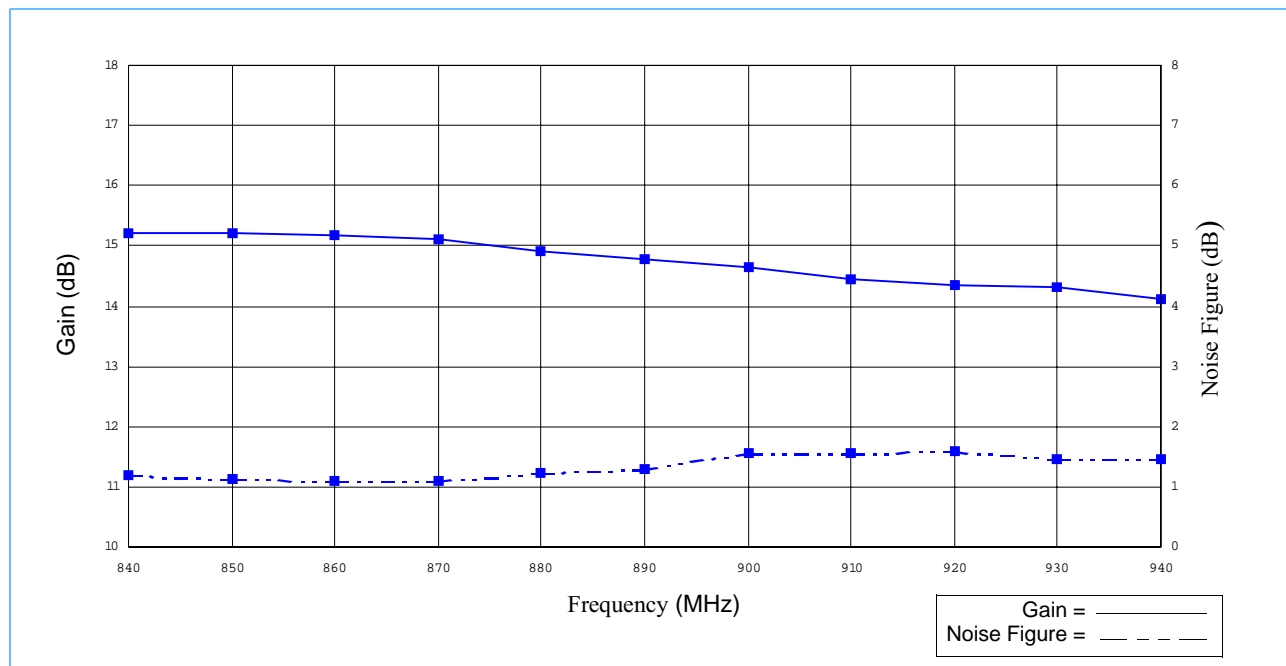
Note: Device characteristics measured with IBM3604012EVBA Evaluation Board Assembly. Optimum external input and output matching to 50 ohm terminations. Input power =-30dBm (-10dBm: Bypass mode); V_{CC} = 2.75 volts, ambient temperature = 25 °C, and frequency = 1960 MHz. Max, Min and Typ values are based on statistical samples from several non-consecutive wafer lots.

Gain and Noise Figure Plots ($V_{CC} = 2.75V$, $T=25$ deg.C)

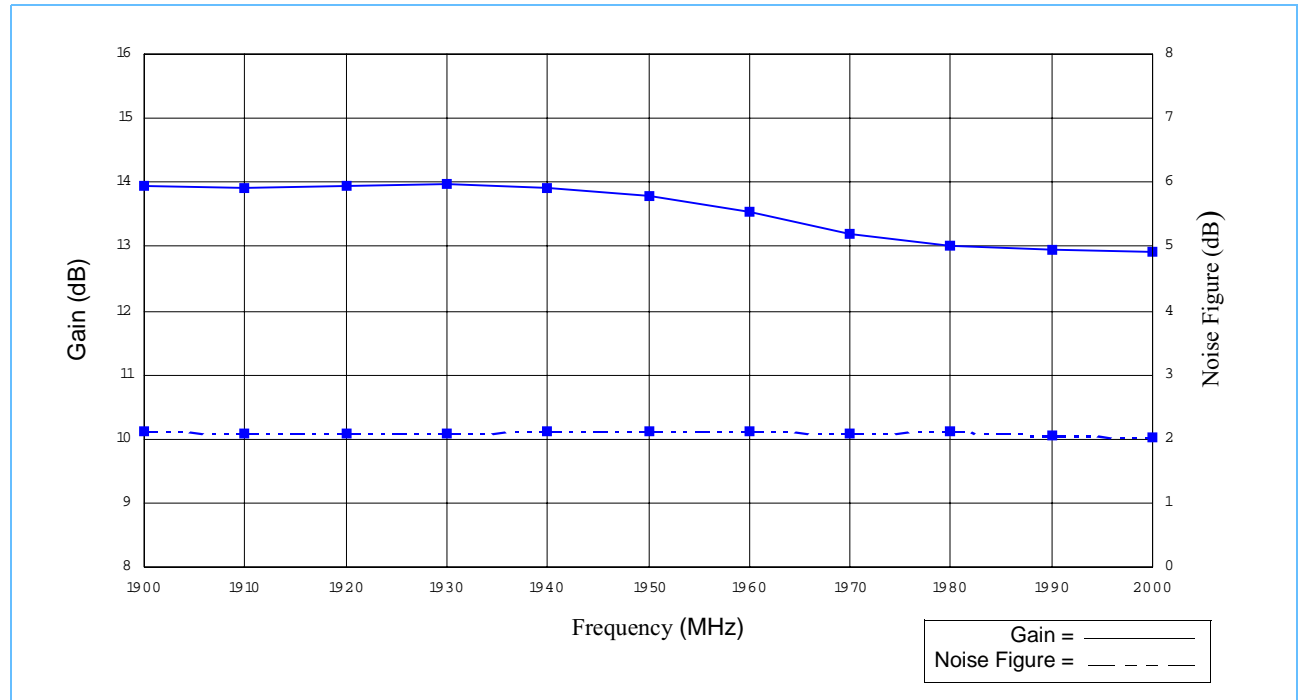
Cellular Band: High Gain and High Linearity Mode



Cellular Band: High Gain and Low Linearity Mode



PCS Band: High Gain and High Linearity Mode



PCS Band: High gain and Low Linearity Mode

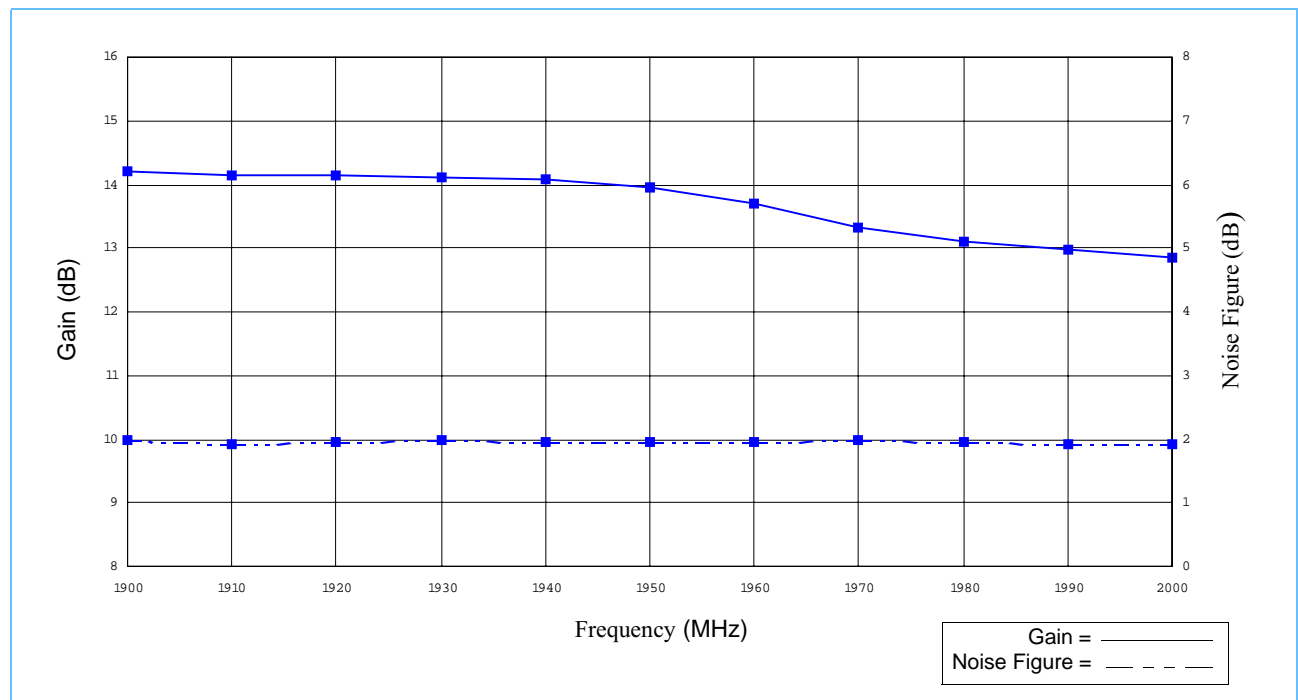


Figure 4. IBM3604012EVBA Evaluation Board Assembly Schematic

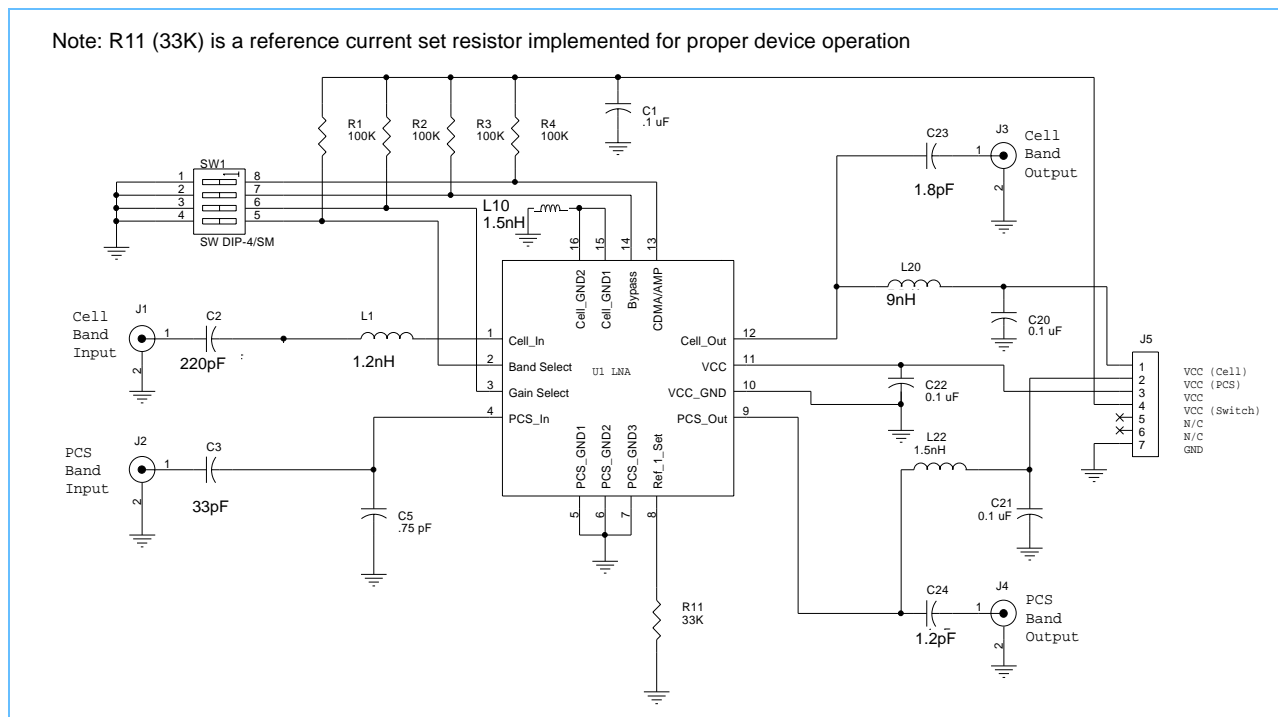


Figure 5. Package Diagram

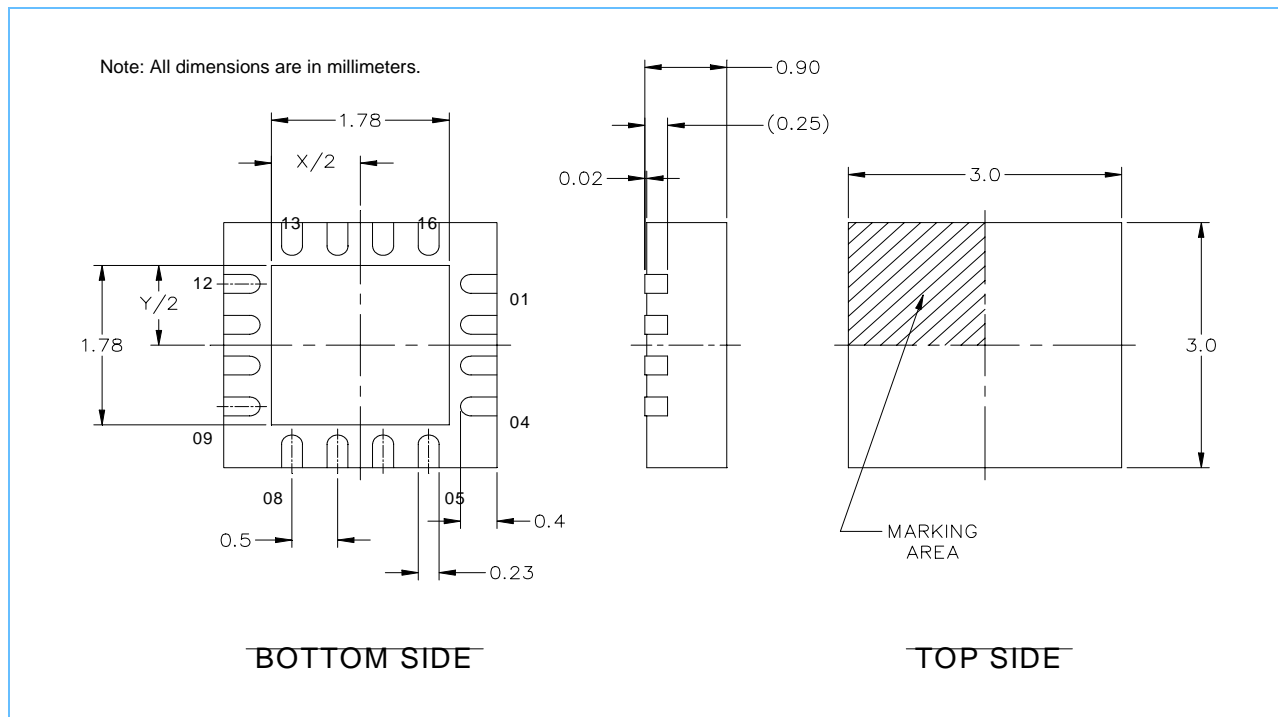
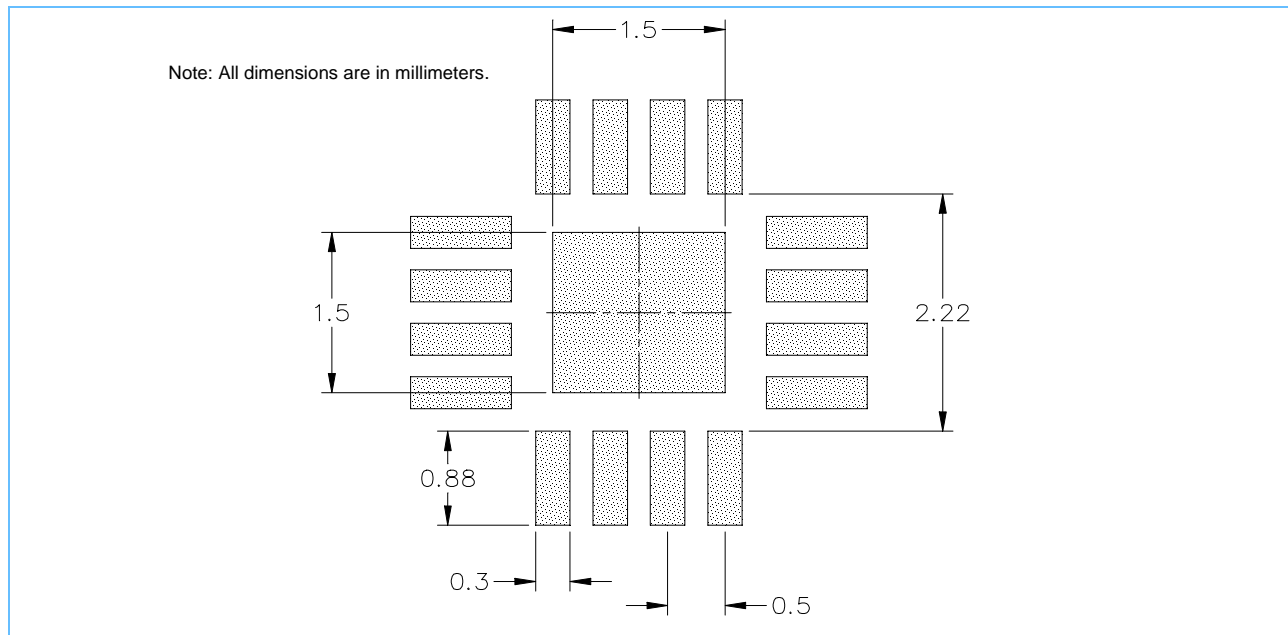


Figure 6. PCB Pad Placement





Document Revision Log

| Rev. | Contents of Modification |
|--------------------|---|
| September 25, 2001 | Initial release (00). |
| October 30, 2001 | Data and board schematic per tests on tape out (01) |
| January 15, 2002 | Data tables updated with split lot values (02) |

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